Wire Wound Chip Common Mode Filters



FEATURES

- Winding type realizes small size and low profile
- Prevention of common mode noise at high frequency
- Excellent solderability
- Operating temperature -40~+125°C (Including self temperature rise)

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APPLICATIONS

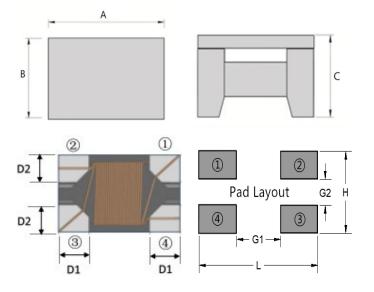
- For Automotive
- Common mode noise suppression of automotive LAN for Flex Ray, CANBUS

PRODUCT IDENTIFICATION

WCM 4532 L-2-510 T F

- 1 2 3 4 5 6 7
- (1) Series Name:Wire Wound Chip Common Mode Filters
- ② Dimensions
- ③ Feature Type:Ferrite
- 4 Number of Lines 2P=2 lines
- (5) Inductance : 510 = 51uH
- ⁶ Packing: Tape & Reel
- T:Hazardous Substance Free Products

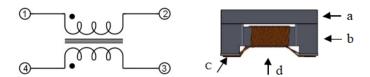
Shapes and Dimensions [Dimensions in mm]



Series:	WCM4532L-2**Series
A(mm)	4.5±0.2
B(mm)	3.2.±0.2
C(mm)	2.8±0.2
D1(mm)	0.90
D2(mm)	1.10
G1(mm)	2.70
G2(mm)	0.70
L(mm)	5.1
H(mm)	3.8



Equivalent Circuit / Materials

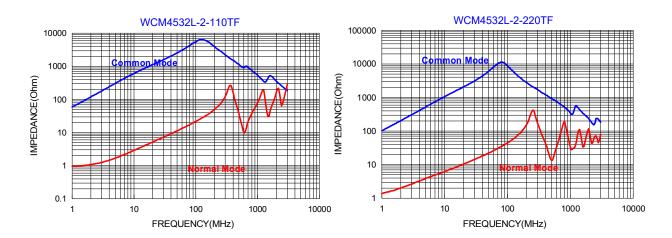


NO.	Description	Specification
а	Upper Plate	Ferrite
b	Core	Ferrite Core
С	Termination	Ag/Ni/Sn
d	Wire	Enameled Copper Wire

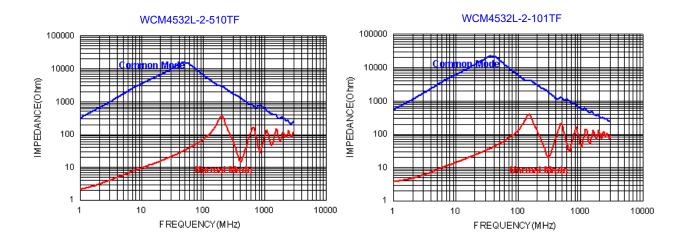
Electrical Characterisitics:

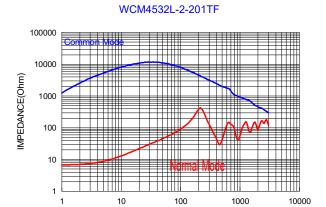
Part Number	Impedance [10MHz]	Inductance [100kHz/0.1V]	DC Resistance	Rated Current	Rated Volt.	IR
Units	(Ω) Min	(uH)	(Ω)Max.	(mA)Max.	(Vdc)	(MΩ)min.
WCM4532L-2-110TF	300	11 +50%/-30%	0.60	360	80	10
WCM4532L-2-220TF	500	22 +50%/-30%	1.00	310	80	10
WCM4532L-2-510TF	1000	51 +50%/-30%	1.00	230	80	10
WCM4532L-2-101TF	2000	100 +50%/-30%	2.00	200	80	10
WCM4532L-2-201TF	5000	200 +50%/-30%	4.50	100	80	10

Curve Frequency (MHz)









FREQUENCY(MHz)

Reliabily and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125℃ (Including self - temperature rise)	
Storage temperature	-40~+125℃ (on board)	
Electrical Performance Tes	st	
Impedance		Keysight E4991B + Keysight 16197A
DCR	Refer to standard electrical characteristics list.	Agilent-34420A Agilent-4338B
Insulation Resistance	Test Voltage : Rated Voltage Time : 1 minute max.	Chroma 19073
Withstand Volt	Test Voltage : Rated Voltage*2.5 times. Time : 1 ~ 5 s. Charge Current : 1 mA max.	Chroma 19073
Temperature Rise Test	Rated Current ∆T 40°C Max	Applied the allowed DC current. Temperature measured by digital surface thermometer.



Reliability Test							
		Preconditioning: Run through reflow for 3 times. (IPC/JEDECJ-STD-020F Classification Reflow Profiles)					
		Temperature: 125±2°C					
Life Test		Applied current : rated current					
		Duration: 1000±12hrs					
		Measured at room temperature after placing for 24 hrs. Preconditioning: Run through reflow for 3 times.					
		(IPC/JEDECJ-STD-020F Classification Reflow Profiles)					
		Humidity : 85±3% RH					
Load Humidity		Temperature : 85°C±2°C					
,		Duration: 1000hrs Min. Bead: with 100% rated current					
		Inductance : with 10% rated current					
	Appearance : No damage. Impedance : within±15% of initial value	Measured at room temperature after placing for 24 hrs. Preconditioning: Run through reflow for 3 times. (IPC/JEDEC J-STD-020F Classification Reflow Profiles) 1. Ba d at 50℃ for 25hrs, measured at room temperature after placing for 4 hrs. 2. aise temperature to 65±2℃ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25℃ in 2.5hrs.					
Moisture Resistance	DCR: within±15% of initial value and shall not exceed the specification value	3 aise temperature to 65±2℃ 90-100%RH in 2.5hrs, and					
	exceed the specification value	keep 3 hours, cool down to 25° C in 2.5hrs, keep at 25° C for 2hrs then keep at -10° C for 3hrs.					
		4 eep at 25% 80-100%RH for 15min and vibrate at the					
		frequency of 10 to 55 Hz to 10 Hz, measured at room temperature after placing for 1~2 hrs. Preconditioning: Run through reflow for 3 times. (IPC/JEDEC J-STD-020F Classification Reflow Profiles) Condition for 1 cycle Step1: -40±2°C 30±5min					
Thermal Shock		Step2 : 125±2°C ≤0.5min					
		Step3 : 125±2°C 30±5min					
		Number of cycles : 500					
		Measured at room temperature after placing for 24 hrs. Preconditioning: Run through reflow for 3 times.					
		(IPC/JEDEC J-STD-020F Classification Reflow Profiles)					
Vibration		Oscillation Frequency : 10Hz~2kHz~10Hz for 20 minutes Equipment : Vibration checker					
		Total Amplitude : 10g					
		Testing Time : 12 hours (20 minutes, 12 cycles each of 3 orientations)					
Bending	Appearance:No damage. Impedance:within±15% of initial value	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.					
	DCR: within±15% of initial value and shall not exceed the specification value	Peak Normal Wave Velocity					
	CACCCA THE SPECIFICATION VALUE	Type value duration (D) Wave change (Vi)ft/sec					
Observe							
Shock							
		Lead 0 11 Half-sine 11.3					
		3 shocks in each direction along 3 perpendicular axes. (18 shocks).					
Solderability	More than 95% of the terminal electrode should be covered with solder	a. Method B, 4hrs @155°C dry heat @235°C±5°C Testing Time: 5 +0/-0.5 seconds b. Method D category 3. (8hours ± 15 min)@ 260°C±5°C Testing Time: 30 +0/-0.5 seconds					
		Depth: completely cover the termination					
Resistance to Soldering Heat		Temperature(°C) Time(s) Temperature ramp/immersion and emersion rate heat cycles					
		260 ±5 (solder temp) 10 ±1 25mm/s ±6 mm/s 1					
Terminal Strength	Appearance: No damage. Impedance: within±15% of initial value DCR: within±15% of initial value and shall not exceed the specification value	Preconditioning: Run through reflow for 3 times. (IPC/JEDEC J-STD-020F Classification Reflow Profiles) With the component mounted on a PCB with the device to be tested, apply a force (>0805:1kg, <=0805:0.5kg) to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. **Taclius 0,5 mm** DUT **DUT **Wide** **Wide** **Inickness**					
		shear force					



Soldering and Mounting

1. Soldering

Mildly activated rosin fluxes are preferred. Magnetsyc terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

1.1 Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020F)

1.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

- · Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm

- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- · Limit soldering time to 4~5sec.

Fig.1 Soldering Reflow

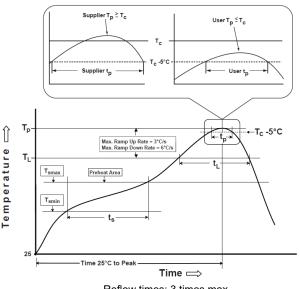
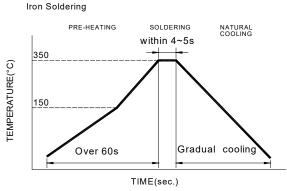


Fig.2 Iron soldering temperature profiles



Iron Soldering times: 1 times max

Reflow times: 3 times max

Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly
$eq:total_continuous_cont$	150°C 200°C 60-120seconds
Ramp-up rate(T _L to T _p)	°ℂ/second max.
$\label{eq:Liquidus} \begin{array}{l} \text{Liquidus temperature}(T_L) \\ \text{Time}(t_L) \\ \text{maintained above } T_L \end{array}$	217°C 60-150 seconds
Classification temperature(T _c)	See Table (1.2)
$\label{eq:tp} \mbox{Time}(t_p) \mbox{ at Tc-} 5^\circ\!\!\!\! \ \mbox{ (Tp should be equal to or less than Tc.)}$	< 30 seconds
Ramp-down rate(T_p to T_L)	6°C /second max.
Time 25℃ to peak temperature	8 minutes max.

Tp: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) Tp should be equal to or less than Tc.

Table (1.2) Package Thickness/Volume and Classification Temperature (Tc)

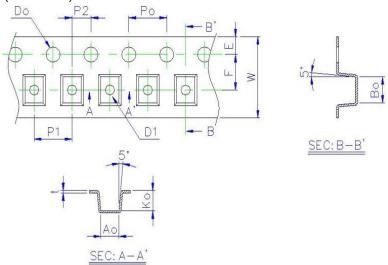
	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
	<1.6mm	°C	260°C	260°C
PB-Free Assembly	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020F



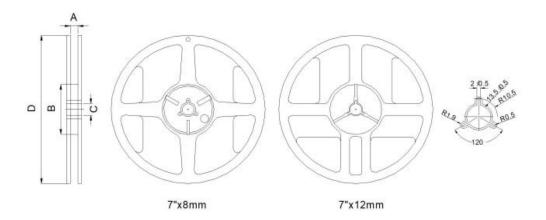
Packaging

(1) Tape Dimensions(Unit:mm)



Size	Ao(mm)	Bo(mm)	Ko(mm)	W(mm)	E(mm)	F(mm)	Po(mm)	P1(mm)	Do(mm)
WCM4532L	3.6±0.10	4.9±0.10	3.0±0.10	12.0±0.10	1.75±0.10	5.50±0.05	4.0±0.05	8.0±0.10	1.5±0.05

(2) Reel



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x12mm	13.5±0.5	60.0±2	13.5±0.5	178.0±2

Part No.	Таре	MPQ
WCM4532L-2-**	Embossed Tape	500PCS